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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	11
Program Memory Size	1.5KB (1K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	14-SOIC (0.154", 3.90mm Width)
Supplier Device Package	14-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c505-04e-sl

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 3-1:	PIC16C505 PINOUT DESCRIPTION
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Name	DIP Pin #	SOIC Pin #	l/O/P Type	Buffer Type	Description
RB0	13	13	I/O	TTL/ST	Bi-directional I/O port/ serial programming data. Can be software programmed for internal weak pull-up and wake-up from SLEEP on pin change. This buffer is a Schmitt Trigger input when used in serial programming mode.
RB1	12	12	I/O	TTL/ST	Bi-directional I/O port/ serial programming clock. Can be software programmed for internal weak pull-up and wake-up from SLEEP on pin change. This buffer is a Schmitt Trigger input when used in serial programming mode.
RB2	11	11	I/O	TTL	Bi-directional I/O port.
RB3/MCLR/Vpp	4	4	Ι	TTL/ST	Input port/master clear (reset) input/programming volt- age input. When configured as MCLR, this pin is an active low reset to the device. Voltage on MCLR/VPP must not exceed VDD during normal device operation. Can be software programmed for internal weak pull-up and wake-up from SLEEP on pin change. Weak pull- up only when configured as RB3. ST when configured as MCLR.
RB4/OSC2/CLKOUT	3	3	I/O	TTL	Bi-directional I/O port/oscillator crystal output. Con- nections to crystal or resonator in crystal oscillator mode (XT and LP modes only, RB4 in other modes). Can be software programmed for internal weak pull-up and wake-up from SLEEP on pin change. In EXTRC and INTRC modes, the pin output can be configured to CLKOUT, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
RB5/OSC1/CLKIN	2	2	I/O	TTL/ST	Bidirectional IO port/oscillator crystal input/external clock source input (RB5 in Internal RC mode only, OSC1 in all other oscillator modes). TTL input when RB5, ST input in external RC oscillator mode.
RC0	10	10	I/O	TTL	Bi-directional I/O port.
RC1	9	9	I/O	TTL	Bi-directional I/O port.
RC2	8	8	I/O	TTL	Bi-directional I/O port.
RC3	7	7	I/O	TTL	Bi-directional I/O port.
RC4	6	6	I/O	TTL	Bi-directional I/O port.
RC5/T0CKI	5	5	I/O	ST	Bi-directional I/O port. Can be configured as T0CKI.
Vdd	1	1	Р	—	Positive supply for logic and I/O pins
Vss	14	14	Р		Ground reference for logic and I/O pins

Legend: I = input, O = output, I/O = input/output, P = power, — = not used, TTL = TTL input, ST = Schmitt Trigger input

4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral functions to control the operation of the device (Table 4-1). The Special Function Registers can be classified into two sets. The Special Function Registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section for each peripheral feature.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets ⁽²⁾
00h	INDF	Uses conte	nts of FSF	to addres	s data me	mory (not a	physical reg	ister)		xxxx xxxx	uuuu uuuu
01h	TMR0	8-bit real-ti	me clock/c	ounter						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Low order 8 bits of PC							1111 1111	1111 1111	
03h	STATUS	RBWUF	_	PAO	TO	PD	Z	DC	С	0001 1xxx	q00q quuu ⁽¹⁾
04h	FSR	Indirect dat	a memory	address p	ointer					110x xxxx	11uu uuuu
05h	OSCCAL	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	_	_	1000 00	uuuu uu
N/A	TRISB	—		I/O contro	l registers					11 1111	11 1111
N/A	TRISC	—		I/O contro	l registers					11 1111	11 1111
N/A	OPTION	RBWU	RBPU	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
06h	PORTB	—		RB5	RB4	RB3	RB2	RB1	RB0	xx xxxx	uu uuuu
07h	PORTC	—		RC5	RC4	RC3	RC2	RC1	RC0	xx xxxx	uu uuuu

TABLE 4-1:SPECIAL FUNCTION REGISTER (SFR) SUMMARY

Legend: Shaded cells not used by Port Registers, read as '0', — = unimplemented, read as '0', x = unknown, u = unchanged, q = depends on condition.

Note 1: If reset was due to wake-up on pin change, then bit 7 = 1. All other rests will cause bit 7 = 0.

Note 2: Other (non-power-up) resets include external reset through MCLR, watchdog timer and wake-up on pin change reset.

4.6 Program Counter

As a program instruction is executed, the Program Counter (PC) will contain the address of the next program instruction to be executed. The PC value is increased by one every instruction cycle, unless an instruction changes the PC.

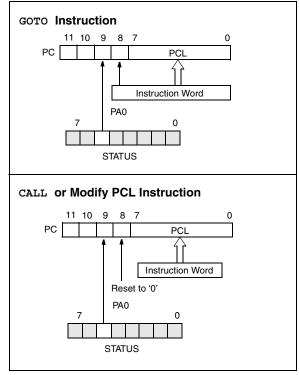
For a GOTO instruction, bits 8:0 of the PC are provided by the GOTO instruction word. The PC Latch (PCL) is mapped to PC<7:0>. Bit 5 of the STATUS register provides page information to bit 9 of the PC (Figure 4-3).

For a CALL instruction, or any instruction where the PCL is the destination, bits 7:0 of the PC again are provided by the instruction word. However, PC<8> does not come from the instruction word, but is always cleared (Figure 4-3).

Instructions where the PCL is the destination, or Modify PCL instructions, include MOVWF PC, ADDWF PC, and BSF PC, 5.

Note: Because PC<8> is cleared in the CALL instruction or any Modify PCL instruction, all subroutine calls or computed jumps are limited to the first 256 locations of any program memory page (512 words long).

FIGURE 4-3: LOADING OF PC BRANCH INSTRUCTIONS -PIC16C505



4.6.1 EFFECTS OF RESET

The Program Counter is set upon a RESET, which means that the PC addresses the last location in the last page (i.e., the oscillator calibration instruction.) After executing MOVLW XX, the PC will roll over to location 00h and begin executing user code.

The STATUS register page preselect bits are cleared upon a RESET, which means that page 0 is pre-selected.

Therefore, upon a RESET, a GOTO instruction will automatically cause the program to jump to page 0 until the value of the page bits is altered.

4.7 <u>Stack</u>

PIC16C505 devices have a 12-bit wide hardware push/pop stack.

A CALL instruction will push the current value of stack 1 into stack 2 and then push the current program counter value, incremented by one, into stack level 1. If more than two sequential CALL's are executed, only the most recent two return addresses are stored.

A RETLW instruction will pop the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential RETLW's are executed, the stack will be filled with the address previously stored in level 2. Note that the W register will be loaded with the literal value specified in the instruction. This is particularly useful for the implementation of data look-up tables within the program memory.

Note 1: There are no STATUS bits to indicate stack overflows or stack underflow conditions.

Note 2: There are no instructions mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETLW, and instructions.

6.1 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

6.1.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-4). Therefore, it is necessary for T0CKI to be high for at least 2T0sc (and a small RC delay of 20 ns) and low for at least 2T0sc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device. When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler, so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

6.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 6-4 shows the delay from the external clock edge to the timer incrementing.

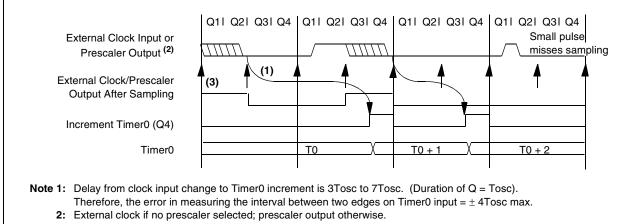


FIGURE 6-4: TIMER0 TIMING WITH EXTERNAL CLOCK

3: The arrows indicate the points in time where sampling occurs.

7.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC16C505 microcontroller has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These features are:

- Oscillator selection
- Reset
 - Power-On Reset (POR)
 - Device Reset Timer (DRT)
 - Wake-up from SLEEP on pin change
- Watchdog Timer (WDT)
- SLEEP
- Code protection
- ID locations
- In-circuit Serial Programming
- Clock Out

The PIC16C505 has a Watchdog Timer, which can be shut off only through configuration bit WDTE. It runs off of its own RC oscillator for added reliability. If using HS, XT or LP selectable oscillator options, there is always an 18 ms (nominal) delay provided by the Device Reset Timer (DRT), intended to keep the chip in reset until the crystal oscillator is stable. If using INTRC or EXTRC, there is an 18 ms delay only on VDD power-up. With this timer on-chip, most applications need no external reset circuitry.

The SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through a change on input pins or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application, including an internal 4 MHz oscillator. The EXTRC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

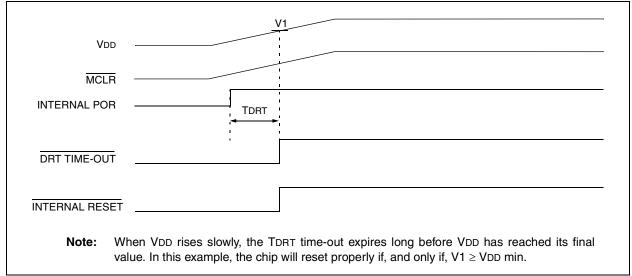
7.1 Configuration Bits

The PIC16C505 configuration word consists of 12 bits. Configuration bits can be programmed to select various device configurations. Three bits are for the selection of the oscillator type, one bit is the Watchdog Timer enable bit, and one bit is the $\overline{\text{MCLR}}$ enable bit. Seven bits are for code protection (Register 7-1).

REGISTER 7-1: CONFIGURATION WORD FOR PIC16C505

CP	CP	CP	CP	CP	CP	MCLRE	CP	WDTE	FOSC2	FOSC1	FOSC0	Register:	CONFIG
bit11	10	9	8	7	6	5	4	3	2	1	bit0	Address ⁽²⁾ :	0FFFh
bit 11-6,	4: CP (ode Pro	tection	bits ⁽¹⁾⁽²	(3)								
bit 5:	1 = F	RE: RB3 RB3/MCL RB3/MCL	.R pin fu	nction is	MCLR	et O, MCLR	internal	ly tied to	Vdd				
bit 3:													
bit 2-0: FOSC<1:0>: Oscillator Selection bits 111 = external RC oscillator/CLKOUT function on RB4/OSC2/CLKOUT pin 110 = external RC oscillator/RB4 function on RB4/OSC2/CLKOUT pin 101 = internal RC oscillator/CLKOUT function on RB4/OSC2/CLKOUT pin 100 = internal RC oscillator/RB4 function on RB4/OSC2/CLKOUT pin 011 = invalid selection 010 = HS oscillator 001 = XT oscillator 000 = LP oscillator													
Note 1:	1: 03FFh is always uncode protected on the PIC16C505. This location contains the MOVLWxx calibration instruction for the INTRC.												
	2: Refer to the PIC16C505 Programming Specifications to determine how to access the con- figuration word. This register is not user addressable during device operation.												
2:	figur	ation wor	d. This	register i	s not us	address	sable ut	ining uevi	ice opera	luon.			

FIGURE 7-10: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): SLOW VDD RISE TIME



7.5 Device Reset Timer (DRT)

In the PIC16C505, the DRT runs any time the device is powered up. DRT runs from RESET and varies based on oscillator selection and reset type (see Table 7-5).

The DRT operates on an internal RC oscillator. The processor is kept in RESET as long as the DRT is active. The DRT delay allows VDD to rise above VDD min. and for the oscillator to stabilize.

Oscillator circuits based on crystals or ceramic resonators require a certain time after power-up to establish a stable oscillation. The on-chip DRT keeps the device in a RESET condition for approximately 18 ms after MCLR has reached a logic high (VIHMCLR) level. Thus, programming RB3/MCLR/VPP as MCLR and using an external RC network connected to the MCLR input is not required in most cases, allowing for savings in cost-sensitive and/or space restricted applications, as well as allowing the use of the RB3/MCLR/VPP pin as a general purpose input.

The Device Reset time delay will vary from chip to chip due to VDD, temperature and process variation. See AC parameters for details.

The DRT will also be triggered upon a Watchdog Timer time-out. This is particularly important for applications using the WDT to wake from SLEEP mode automatically.

Reset sources are POR, MCLR, WDT time-out and Wake-up on pin change. (See Section 7.9.2, Notes 1, 2, and 3, page 37.)

7.6 Watchdog Timer (WDT)

The Watchdog Timer (WDT) is a free running on-chip RC oscillator, which does not require any external components. This RC oscillator is separate from the external RC oscillator of the RB5/OSC1/CLKIN pin and the internal 4 MHz oscillator. That means that the WDT will run even if the main processor clock has been stopped, for example, by execution of a SLEEP instruction. During normal operation or SLEEP, a WDT reset or wake-up reset generates a device RESET.

The $\overline{\text{TO}}$ bit (STATUS<4>) will be cleared upon a Watchdog Timer reset.

The WDT can be permanently disabled by programming the configuration bit WDTE as a '0' (Section 7.1). Refer to the PIC16C505 Programming Specifications to determine how to access the configuration word.

TABLE 7-5: DRT (DEVICE RESET TIMER PERIOD)

	,	
Oscillator Configuration	POR Reset	Subsequent Resets
IntRC & ExtRC	18 ms (typical)	300 μs (typical)
HS, XT & LP	18 ms (typical)	18 ms (typical)

7.6.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). If a longer time-out period is desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT (under software control) by writing to the OPTION register. Thus, a time-out period of a nominal 2.3 seconds can be realized. These periods vary with temperature, VDD and part-topart process variations (see DC specs).

Under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT time-out occurs.

7.6.2 WDT PROGRAMMING CONSIDERATIONS

The CLRWDT instruction clears the WDT and the postscaler, if assigned to the WDT, and prevents it from timing out and generating a device RESET.

The SLEEP instruction resets the WDT and the postscaler, if assigned to the WDT. This gives the maximum SLEEP time before a WDT wake-up reset.

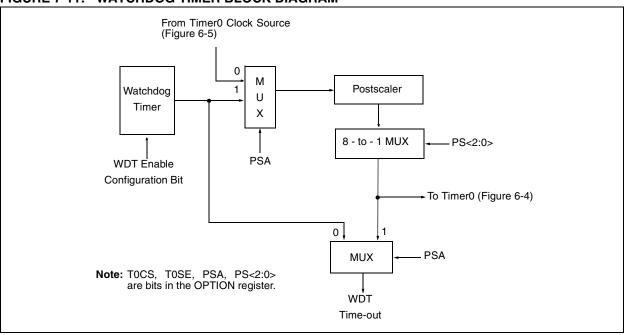


FIGURE 7-11: WATCHDOG TIMER BLOCK DIAGRAM

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets	
N/A	OPTION	RBWU	RBPU	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111	

Legend: Shaded boxes = Not used by Watchdog Timer, — = unimplemented, read as '0', u = unchanged.

7.9 Power-Down Mode (SLEEP)

A device may be powered down (SLEEP) and later powered up (Wake-up from SLEEP).

7.9.1 SLEEP

The Power-Down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the \overline{TO} bit (STATUS<4>) is set, the \overline{PD} bit (STATUS<3>) is cleared and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, driving low or hi-impedance).

It should be noted that a RESET generated by a WDT time-out does not drive the MCLR pin low.

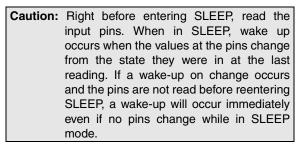
For lowest current consumption while powered down, the T0CKI input should be at VDD or VSS and the RB3/ $\overline{\text{MCLR}}$ /VPP pin must be at a logic high level (VIHMC) if $\overline{\text{MCLR}}$ is enabled.

7.9.2 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. An external reset input on RB3/MCLR/VPP pin, when configured as MCLR.
- 2. A Watchdog Timer time-out reset (if WDT was enabled).
- 3. A change on input pin RB0, RB1, RB3 or RB4 when wake-up on change is enabled.

These events cause a device reset. The $\overline{\text{TO}}$, $\overline{\text{PD}}$, and RBWUF bits can be used to determine the cause of device reset. The $\overline{\text{TO}}$ bit is cleared if a WDT time-out occurred (and caused wake-up). The $\overline{\text{PD}}$ bit, which is set on power-up, is cleared when SLEEP is invoked. The RBWUF bit indicates a change in state while in SLEEP at pins RB0, RB1, RB3 or RB4 (since the last file or bit operation on RB port).



The WDT is cleared when the device wakes from sleep, regardless of the wake-up source.

7.10 Program Verification/Code Protection

If the code protection bit has not been programmed, the on-chip program memory can be read out for verification purposes.

The first 64 locations and the last location (OSCCAL) can be read, regardless of the code protection bit setting.

7.11 ID Locations

Four memory locations are designated as ID locations where the user can store checksum or other codeidentification numbers. These locations are not accessible during normal execution, but are readable and writable during program/verify.

Use only the lower 4 bits of the ID locations and always program the upper 8 bits as '0's.

8.0 INSTRUCTION SET SUMMARY

Each PIC16C505 instruction is a 12-bit word divided into an OPCODE, which specifies the instruction type, and one or more operands which further specify the operation of the instruction. The PIC16C505 instruction set summary in Table 8-2 groups the instructions into byte-oriented, bit-oriented, and literal and control operations. Table 8-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator is used to specify which one of the 32 file registers is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8 or 9-bit constant or literal value.

TABLE 8-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0 (store result in W) d = 1 (store result in file register 'f') Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
WDT	Watchdog Timer Counter
TO	Time-Out bit
PD	Power-Down bit
dest	Destination, either the W register or the specified register file location
[]	Options
()	Contents
\rightarrow	Assigned to
<>	Register bit field
E	In the set of
italics	User defined term (font is courier)

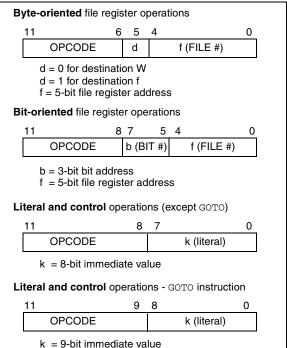
All instructions are executed within a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s.

Figure 8-1 shows the three general formats that the instructions can have. All examples in the figure use the following format to represent a hexadecimal number:

0xhhh

where 'h' signifies a hexadecimal digit.

FIGURE 8-1: GENERAL FORMAT FOR INSTRUCTIONS



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PIC16C505

MOVWF	Move W	to f	
Syntax:	[label]	MOVWF	f
Operands:	$0 \le f \le 3^{-1}$	1	
Operation:	$(W) \to (f$)	
Status Affected:	None		
Encoding:	0000	001f	ffff
Description:	Move da register		e W register to
Words:	1		
Cycles:	1		
Example:	MOVWF	TEMP_REG	3
Before Instru TEMP_R W	EG = =	0xFF 0x4F	
After Instruct TEMP_R W		0x4F 0x4F	

NOP	No Oper							
Syntax:	[label]	NOP						
Operands:	None							
Operation:	No operation							
Status Affected:	None							
Encoding:	0000	0000	0000					
Description:	No opera	ation.						
Words:	1							
Cycles:	1							
Example:	NOP							

OPTION	Load OPTION Register						
Syntax:	[label]	OPTION	1				
Operands:	None						
Operation:	$(W) \rightarrow O$	PTION					
Status Affected:	None						
Encoding:	0000	0000	0010				
Description:	The content of the W register is						
	loaded ir	nto the OF	PTION register.				
Words:	1						
Cycles:	1						
Example	OPTION						
Before Instru	iction						
W	= 0x07	,					
After Instruct OPTION		,					

RETLW	Return with Literal in W					
Syntax:	[<i>label</i>] RETLW k					
Operands:	$0 \le k \le 255$					
Operation:	$k \rightarrow (W);$ TOS \rightarrow PC					
Status Affected:	None					
Encoding:	1000 kkkk kkkk					
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two cycle instruction.					
Words:	1					
Cycles:	2					
Example:	CALL TABLE ;W contains ;table offset ;value. • ;W now has table • ;value.					
TABLE	<pre>ADDWF PC ;W = offset RETLW k1 ;Begin table RETLW k2 ;</pre>					
Before Instru	,					
W =	0x07					
After Instruc W =	tion value of k8					

PIC16C505

SLEEP	Enter SL	EEP Mo	de			
Syntax:	[label]	SLEEP				
Operands:	None					
Operation:	$\begin{array}{l} 00h \rightarrow WDT; \\ 0 \rightarrow WDT \mbox{ prescaler}; \\ 1 \rightarrow \overline{TO}; \\ 0 \rightarrow \overline{PD} \end{array}$					
Status Affected:	TO, PD, F	RBWUF				
Encoding:	0000	0000	0011			
Description:	Time-out status bit (TO) is set. The power down status bit (PD) is cleared. RBWUF is unaffected. The WDT and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See section on SLEEP for more details.					
Words:	1					
Cycles:	1					
Example:	SLEEP					

SUBWF	Sub	otract	W from	n f		
Syntax:	[lab	el]	SUBWF	f,d		
Operands:	-	f ≤ 31 [0,1]				
Operation:	(f) –	• (W) •	\rightarrow (dest))		
Status Affected:	С, Г	DC, Z				
Encoding:	00	00	10df	ffff		
Description:	Subtract (2's complement method) the W register from register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.					
Words:	1					
Cycles:	1					
Example 1:	SUB	WF	REG1,	1		
Before Instru	ction	1				
REG1	=	3				
W C	=	2 ?				
After Instruct	ion					
REG1	=	1				
W	=	2				
С	=	1	; result i	s positive		
Example 2:						
Before Instru						
REG1 W	=	2 2				
C	=	?				
After Instruct	ion					
REG1	=	0				
W	=	2				
C	=	1	; result i	s zero		
Example 3:						
Before Instru		-				
REG1 W	=	1 2				
C	=	?				
After Instruct	ion					
REG1	=	FF				
W	=	2				
С	=	0	; result i	s negative		

9.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC[®] DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

9.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC[®] Flash MCUs and dsPIC[®] Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with incircuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

9.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC[®] Flash microcontrollers and dsPIC[®] DSCs with the powerful, yet easyto-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

9.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC[®] and dsPIC[®] Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming[™].

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

DC CHA	RACTERISTICS	Standard Operating Conditions (unless otherwise specified)Operating temperature $0^{\circ}C \leq TA \leq +70^{\circ}C$ (commercial) $-40^{\circ}C \leq TA \leq +85^{\circ}C$ (industrial) $-40^{\circ}C \leq TA \leq +125^{\circ}C$ (extended)Operating voltage VDD range as described in DC spec Section 10.1 an Section 10.3.					⊦70°C (commercial) 85°C (industrial) 125°C (extended)
Param	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions
No.	Output High Voltage	-					
D090	I/O ports/CLKOUT (Note 3)	Vон	Vdd - 0.7	_	—	v	ІОн = -3.0 mA, VDD = 4.5V, −40°С to +85°С
D090A			VDD - 0.7	—	—	V	IOH = -2.5 mA, VDD = 4.5V, −40°C to +125°C
D092	OSC2		VDD - 0.7	—	—	V	IOH = -1.3 mA, VDD = 4.5V, −40°C to +85°C
D092A			VDD - 0.7	—	—	V	ІОН = -1.0 mA, VDD = 4.5V, −40°C to +125°C
D 400	Capacitive Loading Specs on Output Pins	0			4.5	_	
D100	OSC2 pin	Cosc2			15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2	Сю	—	—	50	pF	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C505 be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

4: Does not include GP3. For GP3 see parameters D061 and D061A.

5: This spec. applies to GP3/MCLR configured as external MCLR and GP3/MCLR configured as input with internal pull-up enabled.

6: This spec. applies when GP3/MCLR is configured as an input with pull-up disabled. The leakage current of the MCLR circuit is higher than the standard I/O logic.

VDD (Volts)	Temperature (°C)	Min	Тур	Max	Units
		RB0/R	B1/RB4		
2.5	-40	38K	42K	63K	W
	25	42K	48K	63K	W
	85	42K	49K	63K	W
	125	50K	55K	63K	W
5.5	-40	15K	17K	20K	W
	25	18K	20K	23K	W
	85	19K	22K	25K	W
	125	22K	24K	28K	W
		R	B3		
2.5	-40	285K	346K	417K	W
	25	343K	414K	532K	W
	85	368K	457K	532K	W
	125	431K	504K	593K	W
5.5	-40	247K	292K	360K	W
	25	288K	341K	437K	W
	85	306K	371K	448K	W
	125	351K	407K	500K	W

TABLE 10-1: PULL-UP RESISTOR RANGES - PIC16C505

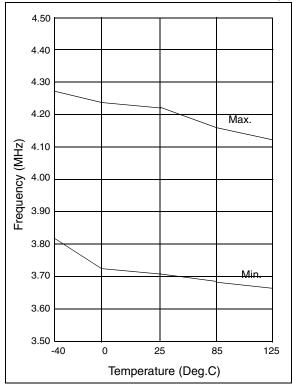
* These parameters are characterized but not tested.

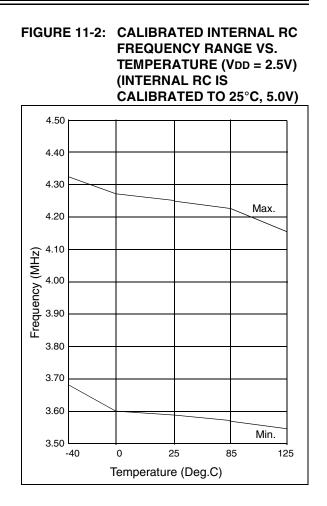
11.0 DC AND AC CHARACTERISTICS -PIC16C505

The graphs and tables provided in this section are for design guidance and are not tested. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3σ) and (mean - 3σ) respectively, where σ is standard deviation.

FIGURE 11-1: CALIBRATED INTERNAL RC FREQUENCY RANGE VS. TEMPERATURE (VDD = 5.0V) (INTERNAL RC IS CALIBRATED TO 25°C, 5.0V)





Oscillator	Frequency	$VDD = 3.0V^{(1)}$	VDD = 5.5V
External RC	4 MHz	240 μA ⁽²⁾	800 μA ⁽²⁾
Internal RC	4 MHz	320 µA	800 µA
ХТ	4 MHz	300 µA	800 µA
LP	32 kHz	19 µA	50 µA
HS	20 MHz	N/A	4.5 mA

TABLE 11-1: DYNAMIC IDD (TYPICAL) - WDT ENABLED, 25°C

Note 1: LP oscillator based on VDD = 2.5V

2: Does not include current through external R&C.

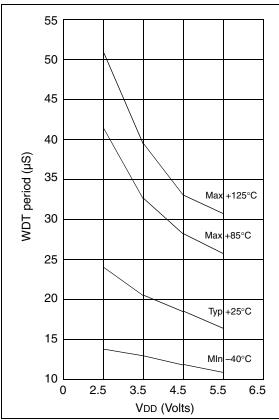
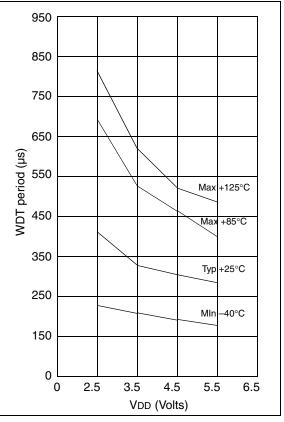
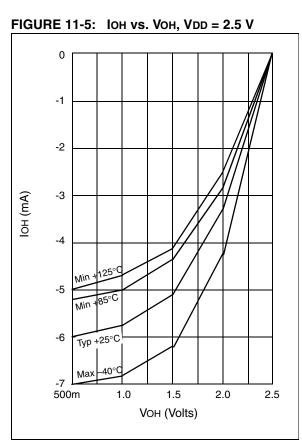


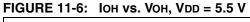
FIGURE 11-3: WDT TIMER TIME-OUT PERIOD vs. Vdd

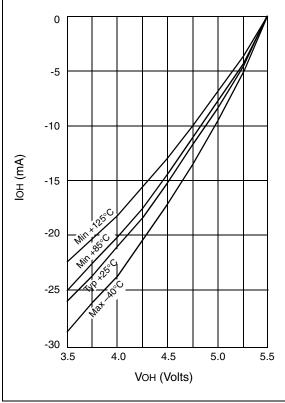
FIGURE 11-4: SHORT DRT PERIOD VS. VDD



PIC16C505







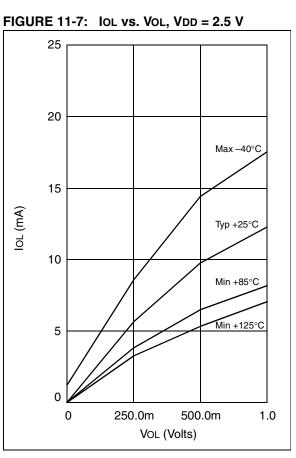
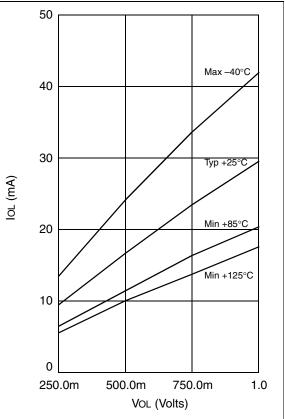


FIGURE 11-8: IOL vs. VOL, VDD = 5.5 V

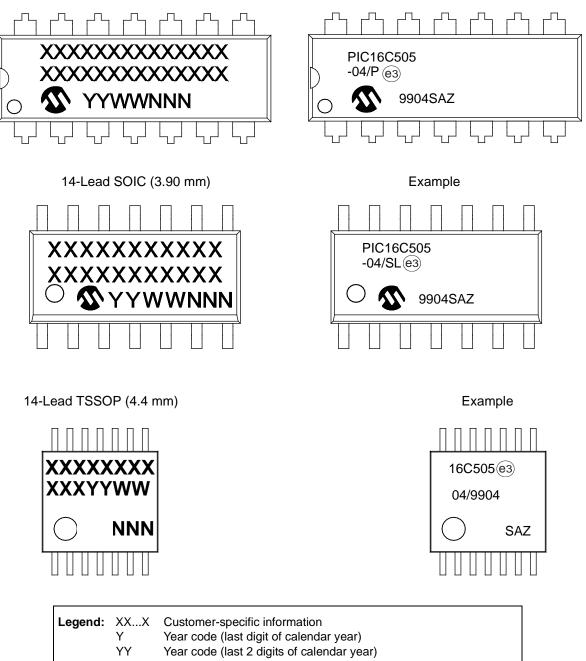


Example

12.0 PACKAGING INFORMATION

12.1 Package Marking Information

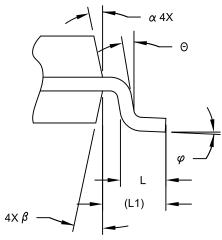
14-Lead PDIP (300 mil)

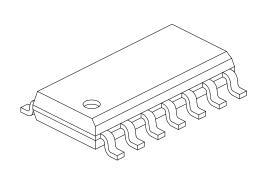


	YY	Year code (last 2 digits of calendar year)					
	WW	Week code (week of January 1 is week '01')					
	NNN	Alphanumeric traceability code					
	e3	Pb-free JEDEC designator for Matte Tin (Sn)					
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3))					
		can be found on the outer packaging for this package.					
Note:	In the eve	ent the full Microchip part number cannot be marked on one line, it will					
	be carried over to the next line, thus limiting the number of available						
	characters for customer-specific information.						

14-Lead Plastic Small Outline (SL) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





VIEW C

	MILLIMETERS				
Dimension Lir	MIN	NOM	MAX		
Number of Pins	N		14		
Pitch	е		1.27 BSC		
Overall Height	А	-	-	1.75	
Molded Package Thickness	A2	1.25	-	-	
Standoff §	A1	0.10	-	0.25	
Overall Width	E		6.00 BSC		
Molded Package Width	E1	3.90 BSC			
Overall Length	D		8.65 BSC		
Chamfer (Optional)	h	0.25 - 0.50			
Foot Length	L	0.40	-	1.27	
Footprint	L1	1.04 REF			
Lead Angle	Θ	0°	-	-	
Foot Angle	φ	0° - 8°			
Lead Thickness	С	0.10 0.25			
Lead Width	b	0.31 0.5			
Mold Draft Angle Top	α	5° - 15°			
Mold Draft Angle Bottom	β	5° - 15°			

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- 3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-065C Sheet 2 of 2

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- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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